

EconoPACK™3 module with Trench/Fieldstop IGBT4 and Emitter Controlled diode and NTC

Features

- Electrical features
 - $V_{CES} = 1700\text{ V}$
 - $I_{C\text{ nom}} = 200\text{ A} / I_{CRM} = 400\text{ A}$
 - Low V_{CESat}
 - $T_{vj\text{ op}} = 150\text{ °C}$
 - Trench IGBT 4
 - V_{CESat} with positive temperature coefficient
- Mechanical features
 - Integrated NTC temperature sensor
 - Standard housing
 - Solder contact technology
 - Isolated base plate



Typical appearance

Potential applications

- High power converters
- Medium voltage converters

Product validation

- Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

Description

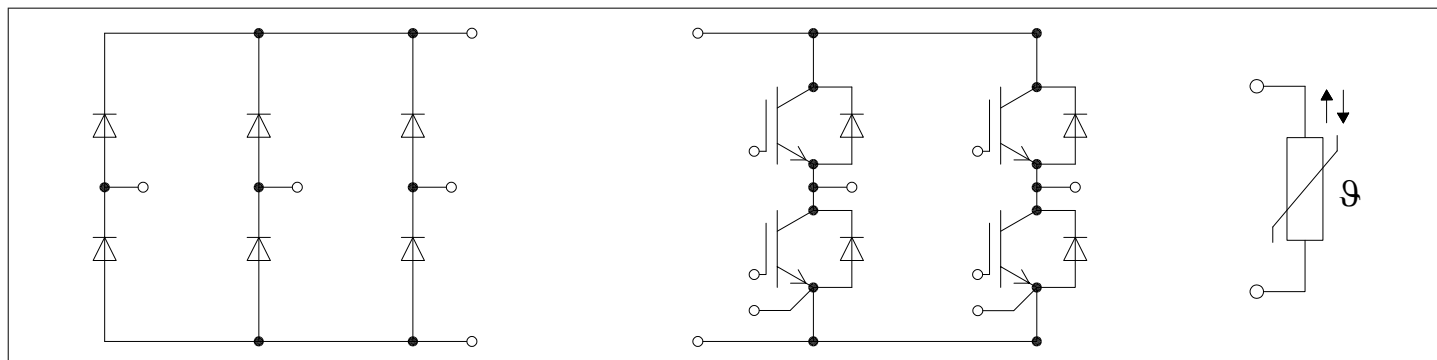


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1 Package

1 Package

Table 1 Insulation coordination

Parameter	Symbol	Note or test condition	Values	Unit
Isolation test voltage	V_{ISOL}	RMS, $f = 50 \text{ Hz}$, $t = 1 \text{ min}$	3.4	kV
Material of module baseplate			Cu	
Internal Isolation		basic insulation (class 1, IEC 61140)	Al_2O_3	
Creepage distance	d_{Creep}	terminal to heatsink	10.0	mm
Clearance	d_{Clear}	terminal to heatsink	7.5	mm
Comparative tracking index	CTI		> 225	
RTI Elec.	RTI	housing	140	°C

Table 2 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Stray inductance module	L_{SCE}			34		nH
Module lead resistance, terminals - chip	$R_{AA'+CC'}$	$T_C = 25^\circ\text{C}$, per switch		3		mΩ
Module lead resistance, terminals - chip	$R_{CC'+EE'}$	$T_C = 25^\circ\text{C}$, per switch		2		mΩ
Storage temperature	T_{stg}		-40		125	°C
Mounting torque for modul mounting	M	- Mounting according to valid application note	M5, Screw	3	6	Nm
Weight	G			300		g

2 IGBT, Inverter

Table 3 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Collector-emitter voltage	V_{CES}		$T_{vj} = 25^\circ\text{C}$	1700	V
Implemented collector current	I_{CN}			200	A
Continuous DC collector current	I_{CDC}	$T_{vj \max} = 175^\circ\text{C}$	$T_C = 80^\circ\text{C}$	200	A
Repetitive peak collector current	I_{CRM}	$t_p = 1 \text{ ms}$		400	A
Gate-emitter peak voltage	V_{GES}			±20	V

Table 4 **Characteristic values**

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Collector-emitter saturation voltage	$V_{CE\ sat}$	$I_C = 200\ A, V_{GE} = 15\ V$	$T_{vj} = 25\ ^\circ C$		1.95	2.30	V
			$T_{vj} = 125\ ^\circ C$		2.35		
			$T_{vj} = 150\ ^\circ C$		2.45		
Gate threshold voltage	V_{GEth}	$I_C = 8\ mA, V_{CE} = V_{GE}, T_{vj} = 25\ ^\circ C$		5.35	5.80	6.25	V
Gate charge	Q_G	$V_{GE} = \pm 15\ V$			2.05		μC
Internal gate resistor	R_{Gint}	$T_{vj} = 25\ ^\circ C$			3.2		Ω
Input capacitance	C_{ies}	$f = 1000\ kHz, T_{vj} = 25\ ^\circ C, V_{CE} = 25\ V, V_{GE} = 0\ V$			16		nF
Reverse transfer capacitance	C_{res}	$f = 1000\ kHz, T_{vj} = 25\ ^\circ C, V_{CE} = 25\ V, V_{GE} = 0\ V$			0.52		nF
Collector-emitter cut-off current	I_{CES}	$V_{CE} = 1700\ V, V_{GE} = 0\ V$	$T_{vj} = 25\ ^\circ C$			1	mA
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0\ V, V_{GE} = 20\ V, T_{vj} = 25\ ^\circ C$				100	nA
Turn-on delay time (inductive load)	t_{don}	$I_C = 200\ A, V_{CE} = 900\ V, V_{GE} = \pm 15\ V, R_{Gon} = 1.8\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.247		μs
			$T_{vj} = 125\ ^\circ C$		0.270		
			$T_{vj} = 150\ ^\circ C$		0.275		
Rise time (inductive load)	t_r	$I_C = 200\ A, V_{CE} = 900\ V, V_{GE} = \pm 15\ V, R_{Gon} = 1.8\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.076		μs
			$T_{vj} = 125\ ^\circ C$		0.079		
			$T_{vj} = 150\ ^\circ C$		0.080		
Turn-off delay time (inductive load)	t_{doff}	$I_C = 200\ A, V_{CE} = 900\ V, V_{GE} = \pm 15\ V, R_{Goff} = 1.8\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.460		μs
			$T_{vj} = 125\ ^\circ C$		0.610		
			$T_{vj} = 150\ ^\circ C$		0.649		
Fall time (inductive load)	t_f	$I_C = 200\ A, V_{CE} = 900\ V, V_{GE} = \pm 15\ V, R_{Goff} = 1.8\ \Omega$	$T_{vj} = 25\ ^\circ C$		0.290		μs
			$T_{vj} = 125\ ^\circ C$		0.511		
			$T_{vj} = 150\ ^\circ C$		0.580		
Turn-on energy loss per pulse	E_{on}	$I_C = 200\ A, V_{CE} = 900\ V, L_\sigma = 35\ nH, V_{GE} = \pm 15\ V, R_{Gon} = 1.8\ \Omega, di/dt = 1250\ A/\mu s (T_{vj} = 150\ ^\circ C)$	$T_{vj} = 25\ ^\circ C$		72.3		mJ
			$T_{vj} = 125\ ^\circ C$		95.1		
			$T_{vj} = 150\ ^\circ C$		101		
Turn-off energy loss per pulse	E_{off}	$I_C = 200\ A, V_{CE} = 900\ V, L_\sigma = 35\ nH, V_{GE} = \pm 15\ V, R_{Goff} = 1.8\ \Omega, dv/dt = 5150\ V/\mu s (T_{vj} = 150\ ^\circ C)$	$T_{vj} = 25\ ^\circ C$		38.4		mJ
			$T_{vj} = 125\ ^\circ C$		63.4		
			$T_{vj} = 150\ ^\circ C$		71.2		
SC data	I_{SC}	$V_{GE} \leq 15\ V, V_{CC} = 1000\ V, V_{CEmax} = V_{CES} - L_{sCE} \cdot di/dt$	$t_P \leq 10\ \mu s, T_{vj} = 150\ ^\circ C$		770		A
Thermal resistance, junction to case	R_{thJC}	per IGBT				0.155	K/W

Table 4 Characteristic values (continued)

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Thermal resistance, case to heatsink	R_{thCH}	per IGBT, $\lambda_{grease} = 1 \text{ W/(m}^2\text{K)}$		0.0710		K/W
Temperature under switching conditions	$T_{vj\text{ op}}$		-40		150	°C

3 Diode, Inverter

Table 5 Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit
Repetitive peak reverse voltage	V_{RRM}	$T_{vj} = 25 \text{ °C}$	1700	V
Continuous DC forward current	I_F		200	A
Repetitive peak forward current	I_{FRM}	$t_P = 1 \text{ ms}$	400	A
I^2t - value	I^2t	$t_P = 10 \text{ ms}, V_R = 0 \text{ V}$	$T_{vj} = 125 \text{ °C}$	A^2s
			$T_{vj} = 150 \text{ °C}$	

Table 6 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Forward voltage	V_F	$I_F = 200 \text{ A}, V_{GE} = 0 \text{ V}$	$T_{vj} = 25 \text{ °C}$	1.80	2.35	V
			$T_{vj} = 125 \text{ °C}$	1.90		
			$T_{vj} = 150 \text{ °C}$	1.95		
Peak reverse recovery current	I_{RM}	$V_R = 900 \text{ V}, I_F = 200 \text{ A}, V_{GE} = -15 \text{ V}, -di_F/dt = 1250 \text{ A/}\mu\text{s} (T_{vj} = 150 \text{ °C})$	$T_{vj} = 25 \text{ °C}$	112		A
			$T_{vj} = 125 \text{ °C}$	126		
			$T_{vj} = 150 \text{ °C}$	129		
Recovered charge	Q_r	$V_R = 900 \text{ V}, I_F = 200 \text{ A}, V_{GE} = -15 \text{ V}, -di_F/dt = 1250 \text{ A/}\mu\text{s} (T_{vj} = 150 \text{ °C})$	$T_{vj} = 25 \text{ °C}$	42.7		μC
			$T_{vj} = 125 \text{ °C}$	75.1		
			$T_{vj} = 150 \text{ °C}$	85.2		
Reverse recovery energy	E_{rec}	$V_R = 900 \text{ V}, I_F = 200 \text{ A}, V_{GE} = -15 \text{ V}, -di_F/dt = 1250 \text{ A/}\mu\text{s} (T_{vj} = 150 \text{ °C})$	$T_{vj} = 25 \text{ °C}$	21		mJ
			$T_{vj} = 125 \text{ °C}$	40.8		
			$T_{vj} = 150 \text{ °C}$	46.9		
Thermal resistance, junction to case	R_{thJC}	per diode			0.269	K/W

Table 6 Characteristic values (continued)

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Thermal resistance, case to heatsink	R_{thCH}	per diode, $\lambda_{grease} = 1 \text{ W/(m}^2\text{K)}$		0.0680		K/W
Temperature under switching conditions	$T_{vj, op}$		-40		150	°C

4 Diode, Rectifier

Table 7 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Repetitive peak reverse voltage	V_{RRM}		$T_{vj} = 25 \text{ °C}$	1800	V
Maximum RMS forward current per chip	I_{FRMSM}	$T_C = 95 \text{ °C}$		150	A
Maximum RMS current at rectifier output	I_{RMSM}	$T_C = 95 \text{ °C}$		150	A
Surge forward current	I_{FSM}	$t_p = 10 \text{ ms}$	$T_{vj} = 25 \text{ °C}$	1460	A
			$T_{vj} = 150 \text{ °C}$	1260	
I^2t - value	I^2t	$t_p = 10 \text{ ms}$	$T_{vj} = 25 \text{ °C}$	10700	A ² s
			$T_{vj} = 150 \text{ °C}$	7940	

Table 8 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Forward voltage	V_F	$T_{vj} = 150 \text{ °C}$, $I_F = 150 \text{ A}$		1.00		V
Threshold voltage	$V_{(TO)}$	$T_{vj} = 150 \text{ °C}$		0.76		V
Slope resistance	r_t	$T_{vj} = 150 \text{ °C}$		1.6		mΩ
Reverse current	I_r	$T_{vj} = 150 \text{ °C}$, $V_R = 1800 \text{ V}$		1		mA
Thermal resistance, junction to case	R_{thJC}	per diode			0.364	K/W
Thermal resistance, case to heatsink	R_{thCH}	per diode, $\lambda_{paste} = 1 \text{ W/(m}^2\text{K)}$ / $\lambda_{grease} = 1 \text{ W/(m}^2\text{K)}$		0.0680		K/W
Temperature under switching conditions	$T_{vj, op}$		-40		150	°C

Note: The current under continuous operation is limited to 50 A rms per connector pin.

5 NTC-Thermistor

Table 9 Characteristic values

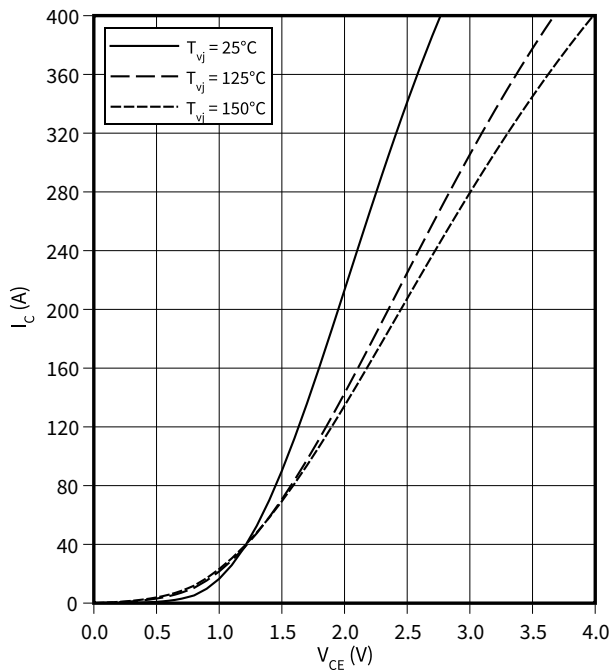
Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Rated resistance	R_{25}	$T_{NTC} = 25\text{ °C}$		5		kΩ
Deviation of R_{100}	$\Delta R/R$	$T_{NTC} = 100\text{ °C}, R_{100} = 493\text{ Ω}$	-5		5	%
Power dissipation	P_{25}	$T_{NTC} = 25\text{ °C}$			20	mW
B-value	$B_{25/50}$	$R_2 = R_{25} \exp[B_{25/50}(1/T_2 - 1/(298,15\text{ K}))]$		3375		K
B-value	$B_{25/80}$	$R_2 = R_{25} \exp[B_{25/80}(1/T_2 - 1/(298,15\text{ K}))]$		3411		K
B-value	$B_{25/100}$	$R_2 = R_{25} \exp[B_{25/100}(1/T_2 - 1/(298,15\text{ K}))]$		3433		K

Note: Specification according to the valid application note.

6 Characteristics diagrams

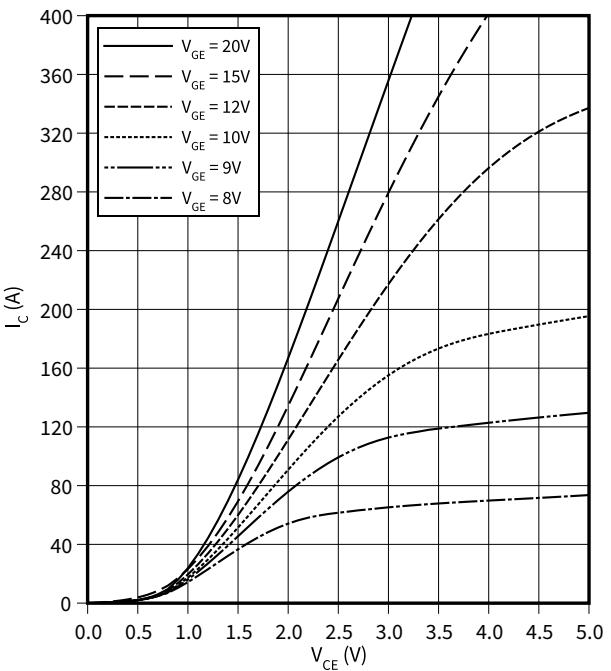
output characteristic (typical), IGBT, Inverter

$I_C = f(V_{CE})$
 $V_{GE} = 15\text{ V}$



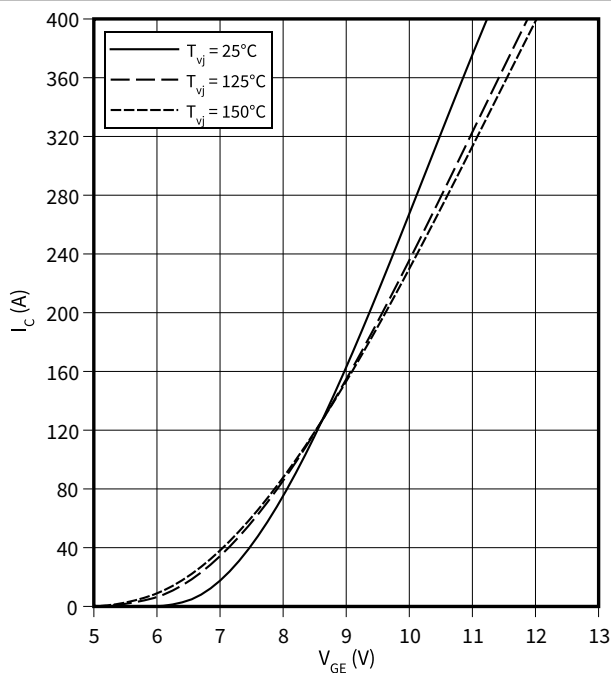
output characteristic (typical), IGBT, Inverter

$I_C = f(V_{CE})$
 $T_{vj} = 150\text{ °C}$



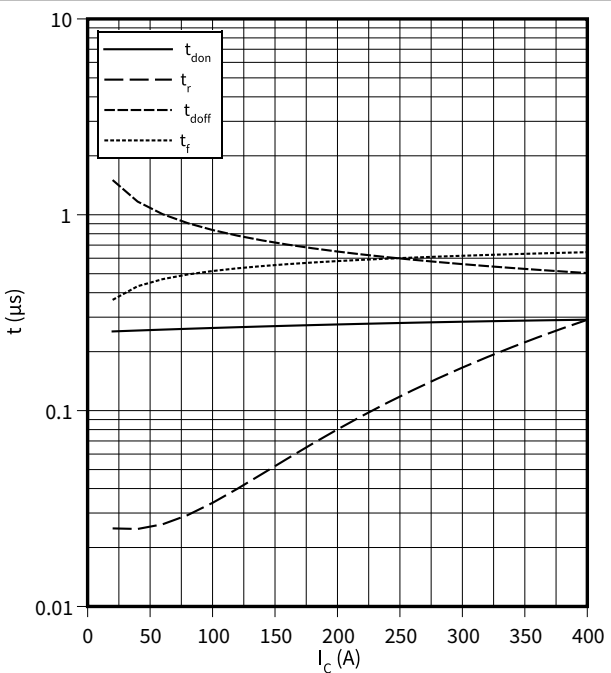
transfer characteristic (typical), IGBT, Inverter

$I_C = f(V_{GE})$
 $V_{CE} = 20\text{ V}$



switching times (typical), IGBT, Inverter

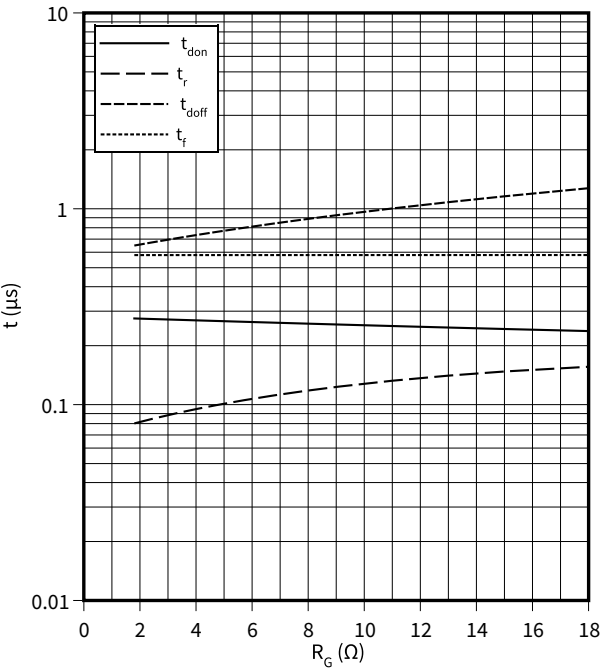
$t = f(I_C)$
 $R_{Goff} = 1.8\text{ }\Omega$, $R_{Gon} = 1.8\text{ }\Omega$, $V_{CE} = 900\text{ V}$, $V_{GE} = -15 / 15\text{ V}$, $T_{vj} = 150\text{ °C}$



6 Characteristics diagrams

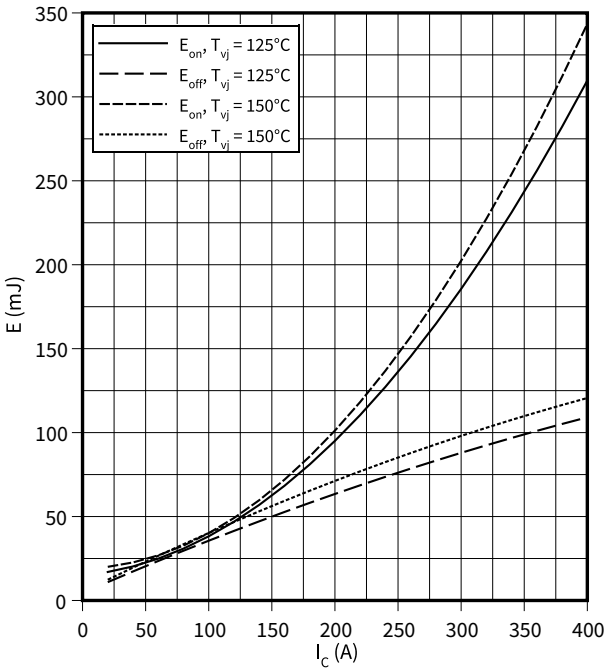
switching times (typical), IGBT, Inverter

$t = f(R_G)$
 $I_C = 200\text{ A}$, $V_{CE} = 900\text{ V}$, $V_{GE} = -15 / 15\text{ V}$, $T_{vj} = 150\text{ °C}$



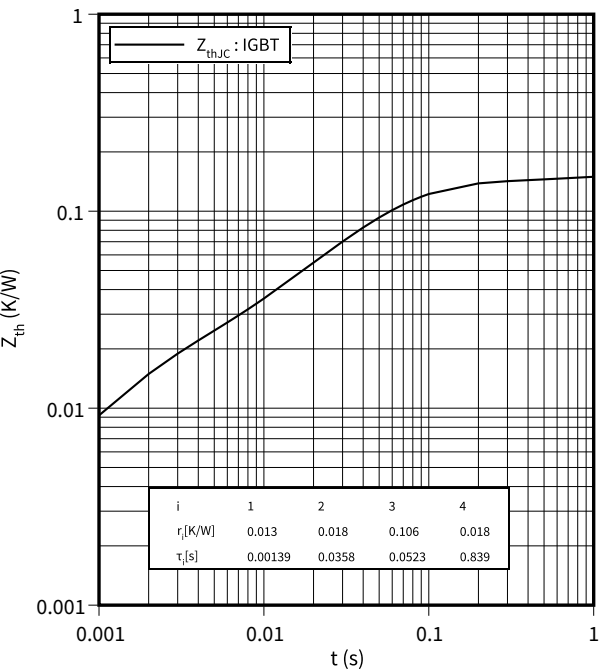
switching losses (typical), IGBT, Inverter

$E = f(I_C)$
 $R_{Goff} = 1.8\text{ }\Omega$, $R_{Gon} = 1.8\text{ }\Omega$, $V_{CE} = 900\text{ V}$, $V_{GE} = -15 / 15\text{ V}$



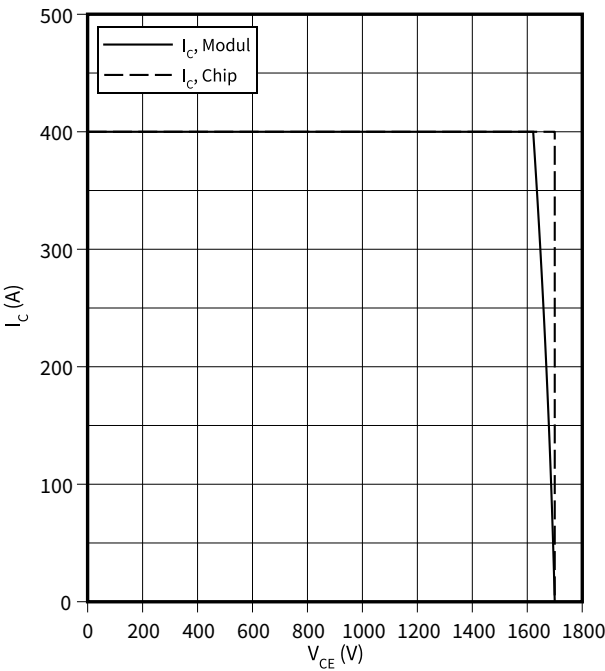
transient thermal impedance , IGBT, Inverter

$Z_{th} = f(t)$



reverse bias safe operating area (RBSOA), IGBT, Inverter

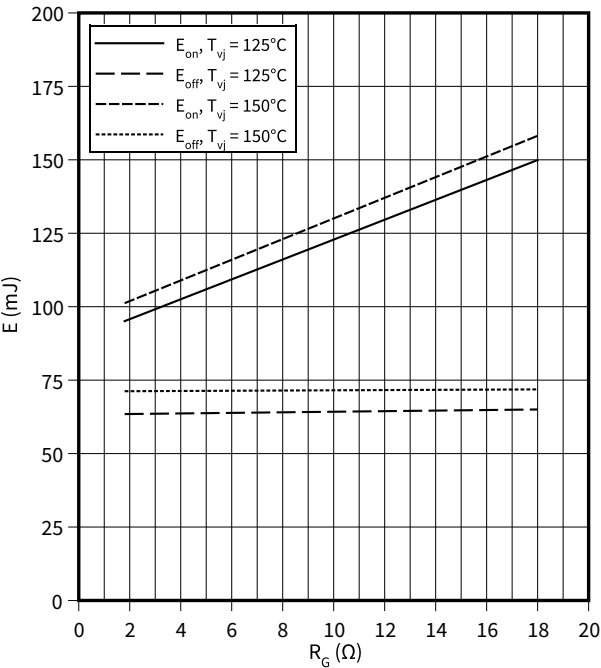
$I_C = f(V_{CE})$
 $R_{Goff} = 1.8\text{ }\Omega$, $V_{GE} = \pm 15\text{ V}$, $T_{vj} = 150\text{ °C}$



6 Characteristics diagrams

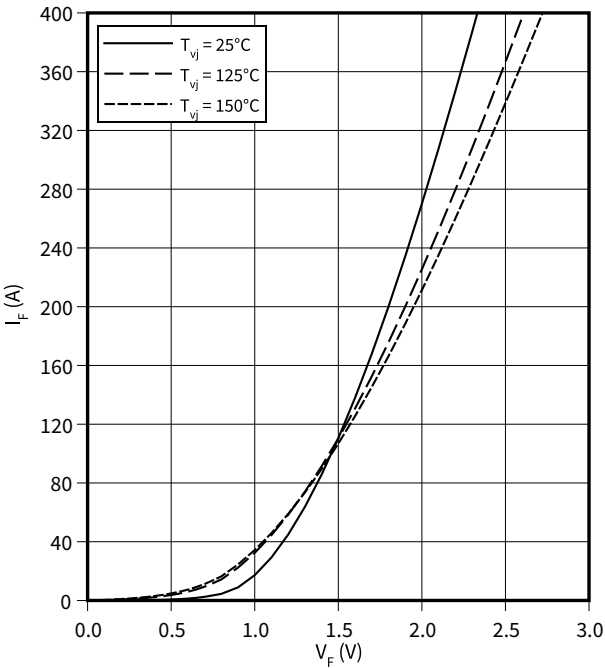
switching losses (typical), IGBT, Inverter

$E = f(R_G)$
 $I_C = 200\text{ A}$, $V_{CE} = 900\text{ V}$, $V_{GE} = -15 / 15\text{ V}$



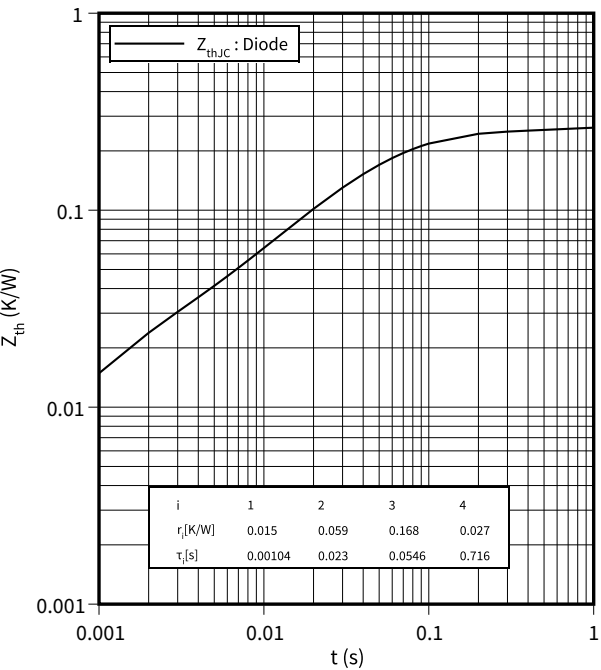
forward characteristic (typical), Diode, Inverter

$I_F = f(V_F)$



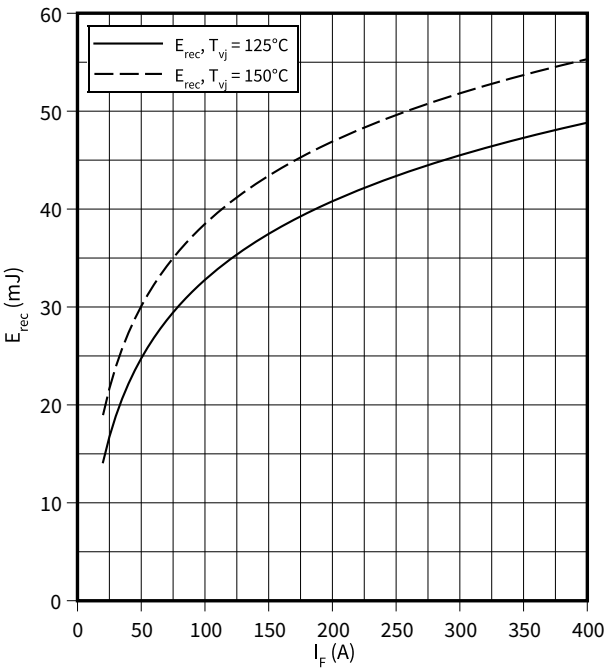
transient thermal impedance , Diode, Inverter

$Z_{th} = f(t)$



switching losses (typical), Diode, Inverter

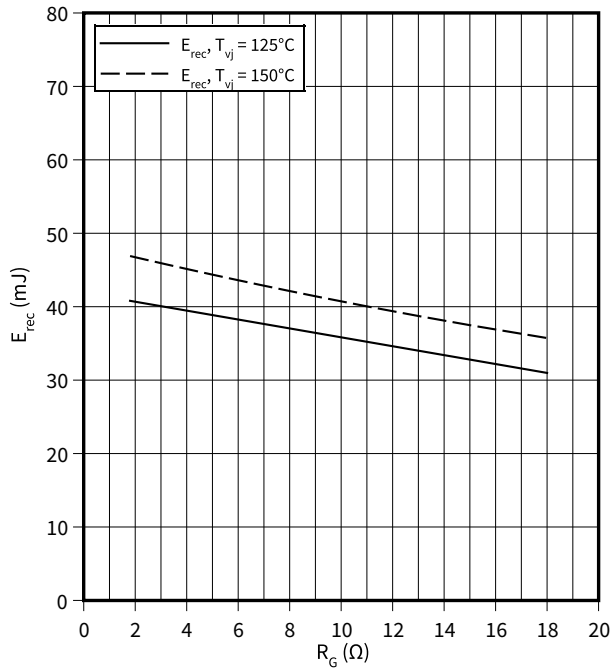
$E_{rec} = f(I_F)$
 $V_{CE} = 900\text{ V}$, $R_{Gon} = R_{Gon}(IGBT)$



6 Characteristics diagrams

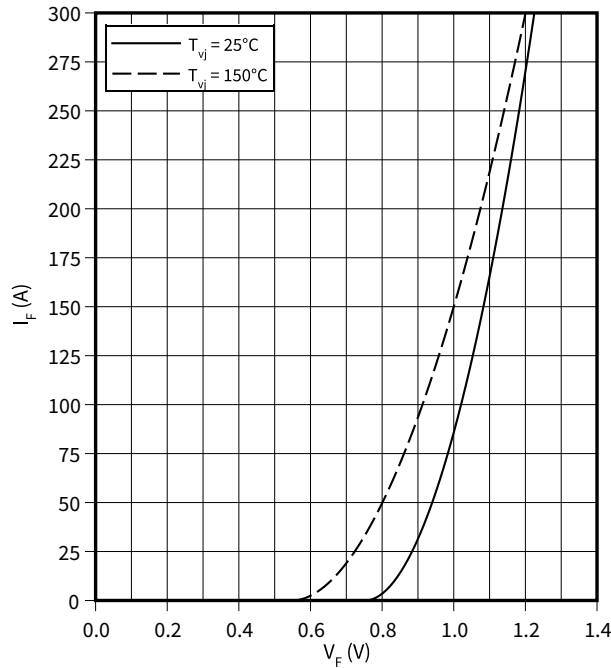
switching losses (typical), Diode, Inverter

$E_{rec} = f(R_G)$
 $V_{CE} = 900\text{ V}, I_F = 200\text{ A}$



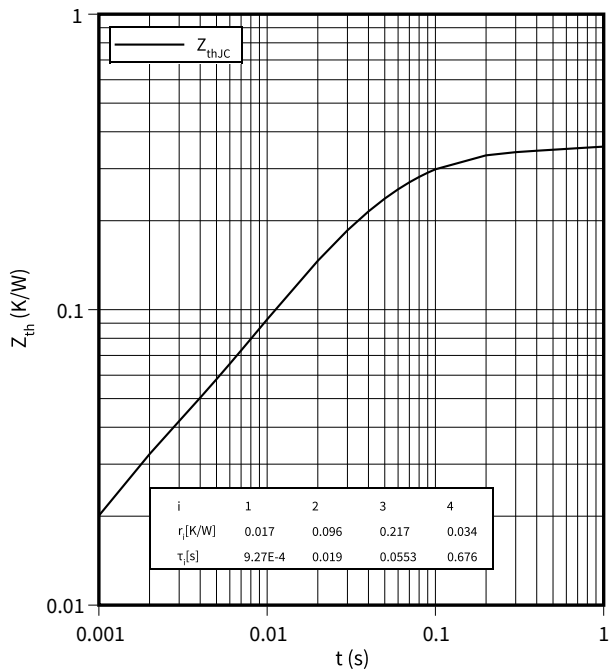
Forward characteristic (typical), Diode, Rectifier

$I_F = f(V_F)$



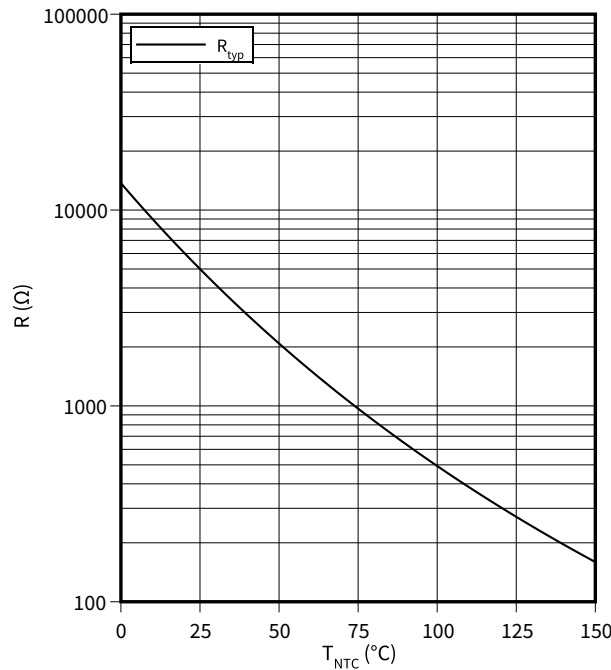
Transient thermal impedance, Diode, Rectifier

$Z_{th} = f(t)$



Temperature characteristic (typical), NTC-Thermistor

$R = f(T_{NTC})$



7 Circuit diagram

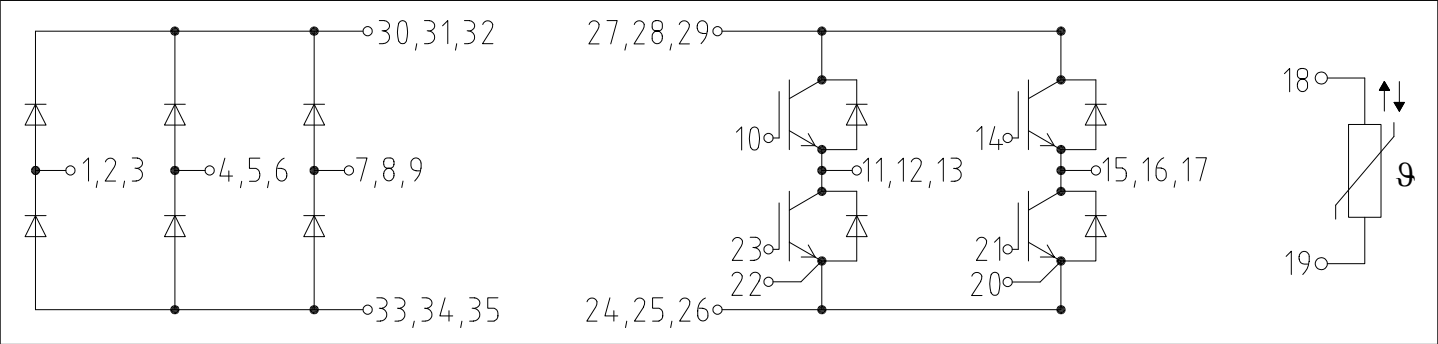


Figure 2

8 Package outlines

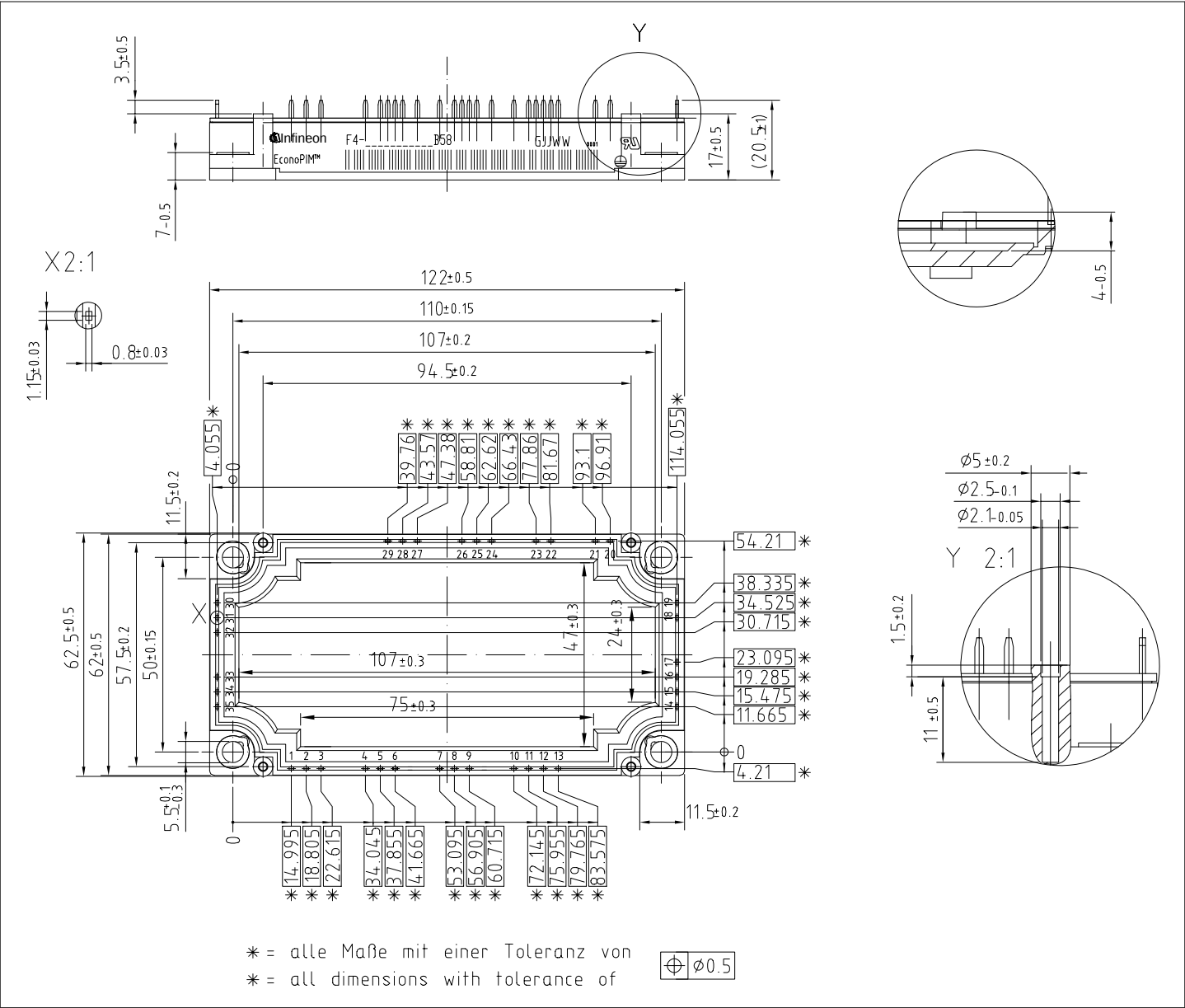


Figure 3

Revision history

Revision history

Document revision	Date of release	Description of changes
1.00	2021-05-11	Final datasheet

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